

DOCUMENT-IDENTIFIER: US 6264477 B1
TITLE: Photolithographically patterned spring contact

BSPR:

This invention generally relates to photolithographically-patterned spring contacts for use in electrically bonding integrated circuits, circuit boards, electrode arrays, or other devices.

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
1	BRS	L1	42514	array same ((integrated) or (circuit adj board))	USPA T; EPO; JPO; DERW ENT	2001/07/3 0 16:10	
2	BRS	L2	0	array same intergated same (circuit adj board)	USPA T; EPO; JPO; DERW ENT	2001/07/3 0 16:09	
3	BRS	L3	22746	array same (integrated adj circuit)	USPA T; EPO; JPO; DERW ENT	2001/07/3 0 16:11	
4	BRS	L4	22746	3 same (circuit board)	USPA T; EPO; JPO; DERW ENT	2001/07/3 0 16:12	
5	BRS	L5	1798	3 same (circuit adj board)	USPA T; EPO; JPO; DERW ENT	2001/07/3 0 17:38	